## FSUSB20

# Low－Power 1－Port High－Speed USB （480Mbps）Switch 

## Features

■ -30 dB off isolation at 250 MHz
－-30 dB non－adjacent channel crosstalk at 250 MHz
■ $4.5 \Omega$ typical on resistance（ $\mathrm{R}_{\mathrm{ON}}$ ）
■ -3 dB bandwidth：$>720 \mathrm{MHz}$
－Low power consumption（1 $\mu \mathrm{A}$ max）
■ Control input：LVTTL compatible
－Bi－directional operation
■ USB high－speed and full－speed signaling capability
■ Space－saving Pb－free packaging

## Applications

■ Cell phone，PDA，digital camera，and notebook

## General Description

FSUSB20 is a low－power high－bandwidth switch spe－ cially designed for switching high－speed USB 2.0 signals in handset and consumer applications，such as cell phones，digital cameras，and notebooks with hubs or controllers with limited USB I／Os．The wide bandwidth （ $>720 \mathrm{MHz}$ ）of this switch allows signals to pass with min－ imum edge and phase distortion．Superior channel－to－ channel crosstalk results in minimal interference．It is compatible with the high－speed USB 2.0 standard．

## Ordering Information

| Order <br> Number | Package <br> Number | Pb－ <br> Free | Top Mark | Package Description |
| :---: | :---: | :---: | :---: | :--- |
| FSUSB20L10X | MAC010A | Yes | EY | 10－Lead MicroPak ${ }^{\text {TM }}, 1.6 \times 2.1 \mathrm{~mm}$ <br> FSUSB20BQX MLP014A |
| Yes | USB20 | 14－Terminal Depopulated Quad Very－Thin Flat Pack No Leads <br> （DQFN），JEDEC MO－241，2．5 $\times 3.0 \mathrm{~mm}$ |  |  |
| FSUSB20MUX | MUA10A | Yes | FSUSB20 | 10－Lead Molded Small Outline Package（MSOP），JEDEC MO－ <br> $187,3.0 m m ~ W i d e ~$ |

[^0]
## Connection Diagrams

Pad Assignments for MicroPak

(Top View)

Pad Assignments for DQFN

(Top Through View)

## Analog Symbol



## Truth Table

| $\mathbf{S}$ | OE | Function |
| :---: | :---: | :---: |
| X | High | Disconnect |
| Low | Low | $\mathrm{A}=\mathrm{B}_{1}$ |
| High | Low | $\mathrm{A}=\mathrm{B}_{2}$ |

Pin Descriptions

| Pin Name | Description |
| :---: | :---: |
| OE | Bus Switch Enable |
| S | Select Input |
| A | Bus A |
| $\mathrm{B}_{1}-\mathrm{B}_{2}$ | Bus B |

## Absolute Maximum Ratings

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

| Symbol | Parameter | Min. | Max. | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply Voltage | -0.5 | +4.6 | V |
| $\mathrm{~V}_{\mathrm{S}}$ | DC Switch Voltage | -0.5 V | $\mathrm{~V}_{\mathrm{CC}}+0.05$ | V |
| $\mathrm{~V}_{\text {IN }}$ | DC Input Voltage ${ }^{(1)}$ | -0.5 | +4.6 |  |
| $\mathrm{I}_{\mathrm{IK}}$ | DC Input Diode Current $\mathrm{V}_{\text {IN }}<0 \mathrm{~V}$ | -50 |  | mA |
| $\mathrm{I}_{\mathrm{OUT}}$ | DC Output Sink Current | 50 |  | mA |
| $\mathrm{I}_{\mathrm{CC}} / \mathrm{I}_{\mathrm{GND}}$ | DC $\mathrm{V}_{\mathrm{CC}} /$ GND Current | $\pm 100$ |  | mA |
| $\mathrm{~T}_{\text {STG }}$ | Storage Temperature Range | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| ESD | Human Body Model | All Pins | 7000 | V |
|  |  | $\mathrm{I} / \mathrm{O}$ to GND | 7000 |  |

## Notes:

1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions ${ }^{(2)}$

| Symbol | Parameter | Min. | Max. | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Power Supply Operating | 3.0 | 3.6 | V |
| $\mathrm{~V}_{\mathrm{IN}}$ | Input Voltage | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{V}_{\mathrm{OUT}}$ | Output Voltage | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{t}_{\mathrm{r}} \mathrm{t}_{\mathrm{f}}$ | Input Rise and Fall Time | Switch Control Input | 0 | 5 |
|  |  |  |  |  |
|  |  | Switch $\mathrm{I} / \mathrm{O}$ | 0 | DC |
| $\mathrm{T}_{\mathrm{A}}$ | Free Air Operating Temperature | -40 | $+85^{\circ}$ | ${ }^{\circ} \mathrm{C}$ |

Notes:
2. Unused control inputs must be held HIGH or LOW. They may not float.

## DC Electrical Characteristics

Typical values are at $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40{ }^{\circ} \mathrm{C}$ to $+85{ }^{\circ} \mathrm{C}$ |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| $\mathrm{V}_{\text {IK }}$ | Clamp Diode Voltage | $\mathrm{I}_{\mathrm{IN}}=-18 \mathrm{~mA}$ | 3.0 |  |  | -1.2 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH Level Input Voltage |  | $\begin{gathered} 3.0 \text { to } \\ 3.6 \end{gathered}$ | 2.0 |  |  | V |
| $\mathrm{V}_{\mathrm{IL}}$ | LOW Level Input Voltage |  | $\begin{gathered} 3.0 \text { to } \\ 3.6 \end{gathered}$ |  |  | 0.8 | V |
| $I_{1}$ | Input Leakage Current | $0 \leq \mathrm{V}_{\text {IN }} \leq 3.6 \mathrm{~V}$ | 3.6 |  |  | $\pm 1.0$ | $\mu \mathrm{A}$ |
| IOFF | OFF-STATE Leakage Current | $0 \leq \mathrm{A}, \mathrm{B} \leq \mathrm{V}_{\mathrm{CC}}$ | 3.6 |  |  | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $\mathrm{R}_{\mathrm{ON}}$ | Switch On Resistance ${ }^{(3)}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{ON}}=8 \mathrm{~mA}$ | 3.0 |  | 5.0 | 7.0 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{IN}}=3.0 \mathrm{~V}, \mathrm{I}_{\mathrm{ON}}=8 \mathrm{~mA}$ | 3.0 |  | 4.5 | 6.5 | $\Omega$ |
| $\Delta \mathrm{R}_{\mathrm{ON}}$ | Delta $\mathrm{R}_{\mathrm{ON}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}-1.5 \mathrm{~V}, \\ & \mathrm{l}_{\mathrm{ON}}=8 \mathrm{~mA} \end{aligned}$ | 3.0 |  | 0.3 |  | $\Omega$ |
| $\mathrm{R}_{\text {FLAT(ON) }}$ | On Resistance Flatness ${ }^{(4)}$ | $\mathrm{l}_{\text {OUT }}=8 \mathrm{~mA}$ | 3.0 |  | 1.0 |  | $\Omega$ |
| $\mathrm{I}_{\mathrm{CC}}$ | Quiescent Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{CC}} \text { or } \mathrm{GND}, \\ & \mathrm{I}_{\mathrm{OUT}}=0 \end{aligned}$ | 3.6 |  |  | 1.0 | $\mu \mathrm{A}$ |

Notes:
3. Measured by the voltage drop between $A$ and $B$ pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.
4. Flatness is defined as the difference between the maximum and minimum value on resistance over the specified range of conditions.

## AC Electrical Characteristics

Typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Units | Figure Number |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |  |
| $\mathrm{t}_{\mathrm{ON}}$ | Turn ON Time S-to-Bus B | $\mathrm{V}_{\mathrm{B}}=0.8 \mathrm{~V}$ | 3.0 to 3.6 |  | 4.8 | 7.0 | ns | Figure 5 Figure 6 |
| $\mathrm{t}_{\text {OFF }}$ | Turn OFF Time S-to-Bus B | $\mathrm{V}_{\mathrm{B}}=0.8 \mathrm{~V}$ | 3.0 to 3.6 |  | 2.2 | 4.0 | ns | Figure 5 Figure 6 |
| $\mathrm{t}_{\text {PD }}$ | Propagation Delay | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$ | 3.0 to 3.6 |  | 0.25 |  | ns | Figure 10 |
| $\mathrm{O}_{\text {IRR }}$ | Non-Adjacent OFF-Isolation | $\begin{aligned} & \mathrm{f}=250 \mathrm{MHz}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega \end{aligned}$ | 3.0 to 3.6 |  | -26.0 |  | dB | Figure 7 |
| $\mathrm{X}_{\text {TALK }}$ | Non-Adjacent Channel Crosstalk | $\begin{aligned} & \mathrm{f}=250 \mathrm{MHz}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | 3.0 to 3.6 |  | -45.0 |  | dB | Figure 8 |
| BW | -3dB Bandwidth | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}$ | 3.0 to 3.6 |  | 750 |  | MHz | Figure 9 |
|  |  | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ |  |  | 435 |  |  |  |

USB Related AC Electrical Characteristics
Typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Units | Figure Number |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |  |
| ${ }^{\text {t }}$ K(0) | Channel-to-Channel Skew | $C_{L}=10 \mathrm{FF}$ | 3.0 to 3.6 |  | 0.051 |  | ns | Figure 10 Figure 11 |
| $\mathrm{t}_{\text {SK(P) }}$ | Skew of Opposite Transition of the Same Output | $C_{L}=10 \mathrm{FF}$ | 3.0 to 3.6 |  | 0.020 |  | ns | Figure 10 Figure 11 |
| $\mathrm{T}_{J}$ | Total Jitter | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} \\ & \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=750 \mathrm{ps} \text { at } \\ & 480 \mathrm{Mbps} \end{aligned}$ | 3.0 to 3.6 |  | 0.170 |  | ns |  |

## Capacitance

Typical values are at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

|  |  |  | $\mathbf{T}_{\mathbf{A}}=-\mathbf{4 0}{ }^{\circ} \mathbf{C}$ to $+\mathbf{8 5}{ }^{\circ} \mathbf{C}$ |  |
| :---: | :--- | :--- | :---: | :---: |
| Symbol | Conditions |  | Typ. |  |
| $\mathrm{C}_{\mathrm{IN}}$ | Control Pin Input Capacitance | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ | 2.5 | pF |
| $\mathrm{C}_{\mathrm{ON}}$ | A/B ON Capacitance | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \overline{\mathrm{OE}}=0 \mathrm{~V}$ | 12.0 | pF |
| $\mathrm{C}_{\mathrm{OFF}}$ | Port B OFF Capacitance | $\mathrm{V}_{\mathrm{CC}}$ and $\overline{\mathrm{OE}}=3.3 \mathrm{~V}$ | 4.0 | pF |

## Typical Characteristics



Figure 1. Gain vs. Frequency


Figure 2. OFF Isolation

## Typical Characteristics (Continued)

Frequency Response

$V_{B I A S}=0.5 \mathrm{~V}, V_{C C}=3.3 \mathrm{~V}$

Figure 3. Crosstalk


Figure 4. $\mathrm{R}_{\mathrm{ON}}$

## AC Loading and Waveforms



Note: Input driven by $50 \Omega$ source terminated in $50 \Omega$
Note: $C_{L}$ includes load and stray capacitance
Note: Input PRR = 1.0 MHz, $\mathrm{t}_{\mathrm{W}}=500 \mathrm{~ns}$

Figure 5. AC Test Circuit


Figure 6. AC Waveforms


Figure 7. OFF Isolation Test


Figure 8. Crosstalk Test


Figure 9. Bandwidth Test


Figure 10. Propagation Delay


Figure 11. Pulse Skew $\mathbf{t}_{\mathbf{S K}(\mathrm{P})}$


Figure 12. Output Skew $\mathbf{t}_{\mathbf{S K}(0)}$

## Tape and Reel Specifications

## Tape Format for MicroPak

Dimensions are in millimeters unless otherwise noted.

| Package <br> Designator | Tape <br> Section | Number <br> Cavities | Cavity <br> Status | Cover Tape <br> Status |
| :---: | :---: | :---: | :---: | :---: |
| L10X | Leader (Start End) | $125(t y p)$ | Empty | Sealed |
|  | Carrier | 5000 | Filled | Sealed |
|  | Trailer (Hub End) | $75($ typ | Empty | Sealed |

## Tape Dimension

Dimensions are in millimeters unless otherwise noted.


| 10 | 300056 | $2.30 \pm 0.05$ | $1.78 \pm 0.05$ | $0.68 \pm 0.05$ |
| :---: | :--- | :--- | :--- | :--- |
| 8 | 300038 | $1.78 \pm 0.05$ | $1.78 \pm 0.05$ | $0.68 \pm 0.05$ |
| 6 | 300033 | $1.60 \pm 0.05$ | $1.15 \pm 0.05$ | $0.70 \pm 0.05$ |

. ACCUMULATED 50 SPROCKETS, SPROCKET HOLE PITCH IS $200.00 \pm 0.30 \mathrm{MM}$
2. NO INDICATED CORNER RADIUS IS 0.127 MM
. CAMBER NOT TO EXCEED 1MM IN 100MM
4. SMALLEST ALLOWABLE BENDING RADIUS
5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE


SCALE: 6x

## Reel Dimension for MicroPak

Dimensions are in inches (millimeters) unless otherwise noted.


| Tape Size | A | $\mathbf{B}$ | $\mathbf{C}$ | $\mathbf{D}$ | $\mathbf{N}$ | W1 | W2 | W3 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 7.0 | 0.059 | 0.512 | 0.795 | 2.165 | $0.331+0.059 /-0.000$ | 0.567 | W1 $+0.078 /-0.039$ |
| $(8 \mathrm{~mm})$ | $(177.8)$ | $(1.50)$ | $(13.00)$ | $(20.20)$ | $(55.00)$ | $(8.40+1.50 /-0.00)$ | $(14.40)$ | $(\mathrm{W} 1+2.00 /-1.00)$ |

## Tape Format for DQFN

Dimensions are in millimeters unless otherwise notes.

| Package <br> Designator | Tape <br> Section | Number <br> Cavities | Cavity <br> Status | Cover Tape <br> Status |
| :---: | :---: | :---: | :---: | :---: |
| BQX | Leader (Start End) | 125 (typ) | Empty | Sealed |
|  | Carrier | $2500 / 3000$ | Filled | Sealed |
|  | Trailer (Hub End) | 75 (typ) | Empty | Sealed |

## Tape Dimensions

Dimensions are in millimeters unless otherwise noted.


| Dimensions are in millimeters |  |  | $\xrightarrow{\text { Ao }}$ |  |  | User Direction of Feed |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  |  |  |  |  |
| Package | $\begin{gathered} \text { AO } \\ +/-0.10 \\ \hline \end{gathered}$ | $\begin{gathered} \mathrm{Bo} \\ +\ldots-0.10 \\ \hline \end{gathered}$ |  |  |  | $\begin{gathered} D \\ +/-0.05 \end{gathered}$ | $\mathrm{D}_{1}$ min. | $\begin{gathered} \mathrm{E} \\ +/-0.1 \\ \hline \end{gathered}$ | $\begin{gathered} F \\ +/-0.1 \end{gathered}$ | $\begin{gathered} \mathrm{Ko} \\ +/-0.1 \\ \hline \end{gathered}$ | $\begin{gathered} \mathrm{P}_{1} \\ \text { TYP } \end{gathered}$ | $\begin{aligned} & \text { Po } \\ & \text { TYP } \end{aligned}$ | $\begin{gathered} \mathrm{P}_{2} \\ +/-0 / 05 \\ \hline \end{gathered}$ | $\begin{gathered} \text { T } \\ \text { TYP } \end{gathered}$ | $\begin{gathered} \mathrm{Tc} \\ +/-0.005 \\ \hline \end{gathered}$ | $\begin{gathered} W \\ +/-0.3 \\ \hline \end{gathered}$ | $\begin{aligned} & \text { WC } \\ & \text { TYP } \end{aligned}$ |
| $2 \times 2$ | 2.30 | 2.30 | 1.55 | 1.0 | 1.75 | 3.5 | 1.0 | 8 | 4 | 2.0 | 0.3 | 0.07 | 8 | 5.3 |
| $2.5 \times 2.5$ | 2.80 | 2.80 | 1.55 | 1.5 | 1.75 | 5.5 | 0.9 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $2.5 \times 3.0$ | 2.80 | 3.30 | 1.55 | 1.5 | 1.75 | 5.5 | 0.9 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $2.5 \times 3.5$ | 2.80 | 3.80 | 1.55 | 1.5 | 1.75 | 5.5 | 0.9 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $2.5 \times 4.5$ | 2.80 | 4.80 | 1.55 | 1.5 | 1.75 | 5.5 | 0.9 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $3.5 \times 4.5$ | 3.80 | 4.80 | 1.55 | 1.5 | 1.75 | 5.5 | 0.9 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $2.5 \times 3.0$ | 2.80 | 3.30 | 1.55 | 1.5 | 1.75 | 5.5 | 0.9 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $4 \times 4$ | 4.35 | 4.35 | 1.55 | 1.5 | 1.75 | 5.5 | 1.1 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $5 \times 5$ | 5.35 | 5.35 | 1.55 | 1.5 | 1.75 | 5.5 | 1.1 | 8 | 4 | 2.0 | 0.3 | 0.07 | 12 | 9.3 |
| $6 \times 6$ | 6.30 | 6.30 | 1.55 | 1.5 | 1.75 | 7.5 | 1.1 | 12 | 4 | 2.0 | 0.3 | 0.07 | 16 | 13.3 |

Notes: Ao, Bo, and Ko dimensions are determined with respect to the EIA /Jedec RS-481 rotational and lateral movement
requirements (see sketches $A, B$, and $C$ ).

Shipping Reel Dimension

W1 Measured at Hub


DETAIL AA
Dimensions are in millimeters

| Tape Width | Dia A <br> $\max$ | Dim B <br> $\min$ | Dia C <br> $+.5 /-.2$ | Dia D <br> $\min$ | Dia N <br> $\min$ | $\operatorname{Dim}$ W1 <br> $+2 /-0$ | $\operatorname{Dim}$ W2 <br> $\max$ | Dim W3 <br> $($ LSL - USL) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 8 | 330 | 1.5 | 13 | 20.2 | 178 | 8.4 | 14.4 | $7.9 \sim 10.4$ |
| 12 | 330 | 1.5 | 13 | 20.2 | 178 | 12.4 | 18.4 | $11.9 \sim 15.4$ |
| 16 | 330 | 1.5 | 13 | 20.2 | 178 | 16.4 | 22.4 | $15.9 \sim 19.4$ |

## Tape Dimensions for MSOP

Dimensions are in inches (millimeters) unless otherwise specified.


| AQ | $5.30+l-0.1$ |
| :--- | ---: |
| Bo | $3.30+/-0.1$ |
| KQ | $1.30+/-0.1$ |
| K1 | $1.00+/-0.1$ |
| F | $5.50+/-0.1$ |
| P1 | $8.00+/-0.1$ |
| W | $12.00+/-0.3$ |



## Notes:

1. All dimensions are in millimeters.
2. Measured from centerline of sprocket hole to centerline of pocket
3. Cumulative tolerance of ten sprocket holes is $\pm 0.20 \mathrm{~mm}$
4. Other material available

## Reel Dimensions for MSOP

Dimensions are in inches (millimeters) unless otherwise specified


| Tape Size | A | $\mathbf{B}$ | $\mathbf{C}$ | $\mathbf{D}$ | $\mathbf{N}$ | W1 | W2 | W3 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 13 | 0.059 | 0.512 | 0.795 | 7.008 | 0.448 | 0.724 | $0.468-0.606$ |
| $(12 \mathrm{~mm})$ | $(330)$ | $(1.5)$ | $(13)$ | $(20.2)$ | $(178)$ | $(12.4)$ | $(18.4)$ | $(11.9-15.4)$ |

## Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.

A. PACKAGE CONFORMS TO JEDEC MO255, VARIATION UABD
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.

MAC010ARevC

Figure 13. 10-Lead MicroPak, $1.6 \times 2.1 \mathrm{~mm}$

## Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.


BOTTOM VIEW

NOTES:
A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AA
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP014ArevA

Figure 14. 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, $2.5 \times 3.0 \mathrm{~mm}$

## Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.


LAND PATTERN RECOMENDATION


DIMENSIONS ARE IN MILLIMETERS

NOTES:
A. CONFORMS TO JEDEC REGISTRATION MO-187, VARIATION BA, REF NOTE 6, DATE 11/00.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
D. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

MUA10AREVA

Figure 15. 10-Lead Molded Small Outline Package (MSOP), JEDEC MO-187, 3.0mm Wide

## TRADEMARKS

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| ACEx ${ }^{\text {TM }}$ | FACT Quiet Series ${ }^{\text {TM }}$ | OCX ${ }^{\text {™ }}$ | SILENT SWITCHER ${ }^{\text {® }}$ | UniFET ${ }^{\text {TM }}$ |
| :---: | :---: | :---: | :---: | :---: |
| ActiveArray ${ }^{\text {™ }}$ | GlobalOptoisolator ${ }^{\text {TM }}$ | OCXPro ${ }^{\text {™ }}$ | SMART START ${ }^{\text {TM }}$ | UltraFET ${ }^{\text {® }}$ |
| Bottomless ${ }^{\text {TM }}$ | $\mathrm{GTO}^{\text {™ }}$ | OPTOLOGIC ${ }^{\text {® }}$ | SPM ${ }^{\text {™ }}$ | VCX ${ }^{\text {™ }}$ |
| Build it $\mathrm{Now}^{\text {TM }}$ | $\mathrm{HiSeC}^{\text {TM }}$ | OPTOPLANAR ${ }^{\text {TM }}$ | Stealth ${ }^{\text {TM }}$ | Wire ${ }^{\text {TM }}$ |
| CoolFET ${ }^{\text {TM }}$ | $1^{2} \mathrm{C}^{\text {TM }}$ | PACMAN ${ }^{\text {TM }}$ | SuperFET ${ }^{\text {TM }}$ |  |
| CROSSVOLT ${ }^{\text {TM }}$ | $i-\mathrm{Lo}^{\text {TM }}$ | POP ${ }^{\text {™ }}$ | SuperSOT ${ }^{\text {TM }}$-3 |  |
| DOME ${ }^{\text {™ }}$ | ImpliedDisconnect ${ }^{\text {TM }}$ | Power247 ${ }^{\text {TM }}$ | SuperSOT ${ }^{\text {TM }}$-6 |  |
| EcoSPARK ${ }^{\text {™ }}$ | IntelliMAX ${ }^{\text {TM }}$ | PowerEdge ${ }^{\text {TM }}$ | SuperSOT ${ }^{\text {TM }}$-8 |  |
| $\mathrm{E}^{2} \mathrm{CMOS}^{\text {™ }}$ | ISOPLANAR ${ }^{\text {TM }}$ | PowerSaver ${ }^{\text {TM }}$ | SyncFET ${ }^{\text {TM }}$ |  |
| EnSigna ${ }^{\text {™ }}$ | LittleFET ${ }^{\text {m }}$ | PowerTrench ${ }^{\text {® }}$ | TCM ${ }^{\text {™ }}$ |  |
| FACT ${ }^{\text {TM }}$ | MICROCOUPLER ${ }^{\text {TM }}$ | QFET ${ }^{\text {® }}$ | TinyBoost ${ }^{\text {TM }}$ |  |
| FAST ${ }^{\text {® }}$ | MicroFET ${ }^{\text {M }}$ | QS ${ }^{\text {TM }}$ | TinyBuck ${ }^{\text {TM }}$ |  |
| FASTr ${ }^{\text {TM }}$ | MicroPak ${ }^{\text {TM }}$ | QT Optoelectronics ${ }^{\text {TM }}$ | TinyPWM ${ }^{\text {TM }}$ |  |
| FPS ${ }^{\text {TM }}$ | MICROWIRE ${ }^{\text {TM }}$ | Quiet Series ${ }^{\text {TM }}$ | TinyPower ${ }^{\text {TM }}$ |  |
| FRFET ${ }^{\text {TM }}$ | MSX ${ }^{\text {™ }}$ | RapidConfigure ${ }^{\text {TM }}$ | TinyLogic ${ }^{\text {® }}$ |  |
|  | MSXPro ${ }^{\text {TM }}$ | RapidConnect ${ }^{\text {TM }}$ | TINYOPTO ${ }^{\text {™ }}$ |  |
| Across the board. Around the world. ${ }^{\text {TM }}$ |  | $\mu$ SerDes ${ }^{\text {TM }}$ | TruTranslation ${ }^{\text {TM }}$ |  |
| The Power Franchise ${ }^{\text {® }}$ |  | ScalarPump ${ }^{\text {TM }}$ | UHC ${ }^{\text {™ }}$ |  |
| Programmable Active Droop ${ }^{\text {TM }}$ |  |  |  |  |

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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS
Definition of Terms

| Datasheet Identification | Product Status | Definition |
| :--- | :--- | :--- |
| Advance Information | Formative or In Design | This datasheet contains the design specifications for <br> product development. Specifications may change in <br> any manner without notice. |
| Preliminary | Full Production | This datasheet contains preliminary data, and <br> supplementary data will be published at a later date. <br> Fairchild Semiconductor reserves the right to make <br> changes at any time without notice to improve <br> design. |
| No Identification Needed | This datasheet contains final specifications. Fairchild <br> Semiconductor reserves the right to make changes at <br> any time without notice to improve design. |  |
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[^0]:    Pb－Free package per JEDEC J－STD－020B．

